ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INCLUSTRIES®	IPC, Bannock	burn, Illinois. A	ll rights reserved u ntions.	under both	This docume level parts, t	ent is a decla the declaratio	ration on enco	of the subsompasses a	stances Ill lower	within the level mat	manufactu erials for w	rer listed i	tem. N nanufa	ote: if th	e item is an as s engineering	sembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Tyj http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mate					ous Mater	ials and Mfg Information						
Supplier Information																	
Company name*	Company unique ID				Unique ID Authority						Response Date*						
onsemi													2024-04-19				
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email - Contact*							
Product-Env-Stewards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com							
uthorized Representative*	Title - Representative			Phone - Representative*					Email - Representative*								
Product-Env-Stewards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com							
Requester Item Number	Requester Item Number Mfr Iter		m Number Mfr Item Name			Effective Date Version Manufacturing		ing Site	Weight*		t*	UOM	Unit Type				
	NCD98			8-Bit, 8-Channel ADC with 12C serial interface		2024-04-19							45.4		mg	Each	
Aanufacturing Proccess Inform	nation																
Terminal Plating / Grid Array	Material	Ferminal Base	Alloy	J-STD-020 MS	L Rating	Peak Process		Body Ten	Body Temperature Max Time at Peal		me at Peak	Temperature Number		Number	of Reflow Cyc	eles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy	y 3			260		С		30		seconds 3		3			
omments																	
TTENTION: MSL 3 Rated item requ	iires Bake and l	Dry Pack (after	electrical test)														
or more information regarding mater	rial composition	please refer to	page 3														

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.0	mg	Supplier	Silicon (Si)	7440-21-3		2	mg
Die Attach	1.32	mg	Supplier	Silver (Ag)	7440-22-4		0.99	mg
			Supplier	Epoxy resins	129915-35-1		0.33	mg
Lead Frame	20.76	mg	Supplier	Iron (Fe)	7439-89-6		0.3944	mg
			Supplier	Copper (Cu)	7440-50-8		20.3656	mg
Mold Compound-Black	19.0	mg		Epoxy resin	proprietary data		0.95	mg
			Supplier	Phenolic Resin	Proprietary Data		0.95	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.38	mg
			Supplier	Carbon Black (C)	1333-86-4		0.095	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		16.625	mg
Plating	2.12	mg	Supplier	Palladium (Pd)	7440-05-3		0.1611	mg
			В	Nickel (Ni)	7440-02-0		1.9292	mg
			Supplier	Gold (Au)	7440-57-5		0.0297	mg
Wire Bond - Cu	0.2	mg	Supplier	Copper (Cu)	7440-50-8		0.2	mg